L Number	Hits	Search Text	DB	Time stamp
1	2	jp-10229084-\$.did.	USPAT;	2004/05/17 10:32
		,	US-PGPUB;	
			EPO; JPO;	
			DERWENT	
2	3522	257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls.	USPAT;	2004/05/17 10:36
		438/627.ccls. 438/643.ccls. 438/653.ccls.	US-PGPUB	
3	1271	(257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls.	USPAT;	2004/05/17 10:37
		438/627.ccls. 438/643.ccls. 438/653.ccls.) and (copper cu	US-PGPUB	
		platinum pt) and (platinum pt osmium os ruthenium ru		
		iridium ir rhodium rh)	LICDAT	2004/05/47 40:27
4	866	(257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls.	USPAT;	2004/05/17 10:37
		438/627.ccls. 438/643.ccls. 438/653.ccls.) and ((copper cu	US-PGPUB	
		platinum pt) with (platinum pt osmium os ruthenium ru		
	460	iridium ir rhodium rh))	LICDAT	2004/05/17 10:38
5	469	(((257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls.	USPAT; US-PGPUB	2004/05/17 10.56
		438/627.ccls. 438/643.ccls. 438/653.ccls.) and (copper cuplatinum pt) and (platinum pt osmium os ruthenium ru	03-49-00	
		iridium ir rhodium rh)) and (electromigrat\$5 void)) and		
		(interconnect\$6 diffusion barrier)		
6	1851	((((CU OR COPPER) WITH INTERCON\$10)) AND	USPAT;	2004/05/17 10:39
"	1051	(((CO OK COTTER) WITH INTERCORDING))	US-PGPUB	=====================================
7	61	(257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls.	USPAT;	2004/05/17 10:40
'	02	438/627.ccls. 438/643.ccls. 438/653.ccls.) and ((copper cu	US-PGPUB	
		platinum pt) same (interconnect\$6 diffusion barrier) same		
,		(platinum pt osmium os ruthenium ru iridium ir rhodium rh)		
		same (electromigrat\$5 void))		
8	470	(257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls.	USPAT;	2004/05/17 11:22
		438/627.ccls. 438/643.ccls. 438/653.ccls.) and (((((CU OR	US-PGPUB	
		COPPER) WITH INTERCON\$10)) AND (DIFFUSION ADJ		
		BARRIER)))		
9	55	(((pt OR platinum) WITH INTERCON\$10)) same (diffusion	USPAT;	2004/05/17 12:12
		adj barrier)	US-PGPUB	2004/05/47 42:20
10	289	((RU OR RUTHENIUM or pt or ir or os or rh or iridium or	USPAT;	2004/05/17 12:20
	240	platinum or osmium or rhodium) same electromigration)	US-PGPUB EPO; JPO;	2004/05/17 12:56
11	210	(((RU OR RUTHENIUM or pt or ir or os or rh or iridium or platinum or osmium or rhodium) and electromigration)) and	DERWENT;	2004/03/17 12.30
		(copper or cu)	IBM_TDB	
12	244	((RU OR RUTHENIUM) and (DIFFUSION ADJ BARRIER))	EPO; JPO;	2004/05/17 13:34
12	277	((NO OK NOTHERION) and (DITTOSION NOS BYINGEN))	DERWENT;	2001,00,17 10.01
			IBM_TDB	
13	32	((RUTHENIUM or iridium or platinum or osmium or rhodium)	EPO; JPO;	2004/05/17 13:59
10		and electromigration)	DERWENT;	
			IBM_TDB	
14	478	((257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls.	USPAT;	2004/05/17 14:00
		438/627.ccls. 438/643.ccls. 438/653.ccls.) and (copper cu	US-PGPUB	
		platinum pt) and (platinum pt osmium os ruthenium ru		
		iridium ir rhodium rh)) and (electromigrat\$5 void)		<u></u>